# **E24MUKB2C-HAF**

## **ESD Protection Diode**

#### **Features**

- · Low leakage current
- Halogen and Antimony Free(HAF), RoHS compliant

# 1 2



# SOT-323 Plastic Package

1. Cathode 2. Cathode 3. Anode

### **Applications**

- Computers
- · Communication systems
- · Cellular phones handsets and accessories
- Other telephone sets

# Absolute Maximum Ratings (at T<sub>a</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Peak Pulse Power (tp = 8/20 μs)	$P_PK$	240	W	
Peak Pulse Current (tp = 8/20 μs)	I <sub>PP</sub>	3.8	Α	
ESD (IEC 61000-4-2)	Air Contact	$V_{ESD}$	± 28 ± 24	KV
Junction Temperature		Tj	125	°C
Storage Temperature Range		$T_{stg}$	- 55 to + 150	°C

# Characteristics (at $T_a = 25$ °C unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit
Reverse Working Voltage	$V_{RWM}$	-	-	24	V
Reverse Breakdown Voltage at I <sub>R</sub> = 1 mA, Pin 1 or Pin 2 to Pin 3	V <sub>(BR)R</sub>	25	-	30	V
Reverse Current at $V_R$ = 24 V, Pin 1 or Pin 2 to Pin 3	I <sub>R</sub>	-	-	1	μA
Forward Voltage at I <sub>F</sub> = 10 mA	V <sub>F</sub>	-	-	1.2	V
Clamping Voltage at I <sub>PP</sub> = 3.8 A, tp = 8/20 µs, Pin 1 or Pin 2 to Pin 3	V <sub>C</sub>	ı	-	63	V
Clamping Voltage at $I_{TLP}$ = 4 A, tp = 0.2/100 ns, Pin 1 or Pin 2 to Pin 3 at $I_{TLP}$ =16 A, tp = 0.2/100 ns, Pin 1 or Pin 2 to Pin 3	V <sub>CL</sub>		34.2 37.4	-	V
Junction Capacitance at $V_R = 0 \text{ V}$ , $f = 1 \text{ MHz}$ , Pin 1 or Pin 2 to Pin 3	C <sub>j</sub>	-	25	65	pF
Dynamic Resistance 1)	R <sub>dyn</sub>	-	0.27	-	Ω

 $<sup>^{1)}\,\</sup>mbox{Dynamic}$  Resistance calculated from  $\mbox{I}_{\mbox{\scriptsize TLP}}$  = 4A to  $\mbox{I}_{\mbox{\scriptsize TLP}}$  = 16 A .



#### **Electrical Characteristics Curves**

Fig 1. Pulse Waveform

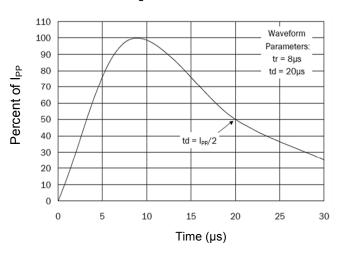


Fig 2. Power Derating Curve

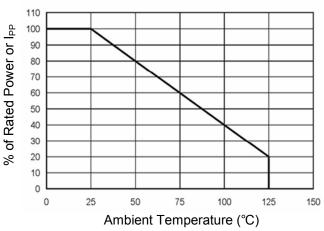


Fig 3. Clamping Voltage Curve

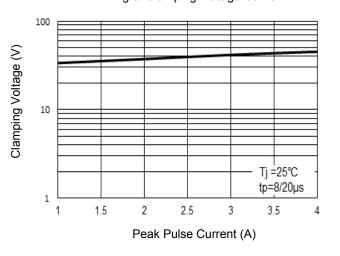


Fig 4. Junction Capacitance

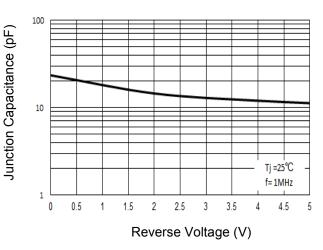
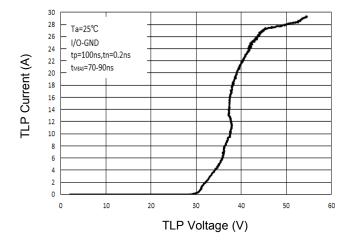


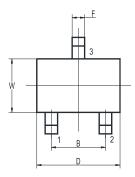
Fig. 5 TLP Curve

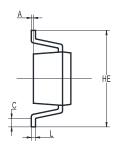


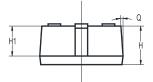
# **E24MUKB2C-HAF**

# Package Outline Dimensions (Units: mm)

**SOT-323** 

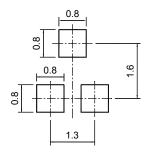






UNIT	Α	В	С	D	Н	H1	HE	F	L	W	Q
mm	0.1	1.4	0.2	2.1	1.0	0.7	2.4	0.35	0.15	1.35	5°
mm	MAX.	1.2	MIN.	1.9	0.8	TYP.	2.0	0.25	0.05	1.15	MAX.

# **Recommended Soldering Footprint**



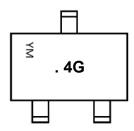
**Packing information** 

Package	Tape Width	Pit	tch	Reel	Size	D D 10 1: 0 1:	
	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

# **Marking information**

- " 4G " = Part No.
- "•" = HAF (Halogen and Antimony Free)
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month

Font type: Arial



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